

60 V, 1 A NPN/NPN low VCEsat (BISS) transistor

11 February 2015

Product data sheet

1. General description

NPN/PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a leadless medium power DFN2020D-6 (SOT1118D) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

NPN/NPN complement: PBSS4160PANS. PNP/PNP complement: PBSS5160PAPS.

2. Features and benefits

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability ${\sf I}_{C}$ and ${\sf I}_{CM}$
- High collector current gain h_{FE} at high I_C
- Reduced Printed-Circuit Board (PCB) requirements
- Exposed heat sink for excellent thermal and electrical conductivity
- High energy efficiency due to less heat generation
- Suitable for Automatic Optical Inspection (AOI) of solder joints
- AEC-Q101 qualified

3. Applications

- Load switch
- Battery-driven devices
- Power management
- Charging circuits
- LED lighting
- Power switches (e.g. motors, fans)

4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor; for the PNP transistor with negative polarity							
V _{CEO}	collector-emitter voltage	open base		-	-	60	V
I _C	collector current			-	-	1	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	1.5	А

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (NPN)						
R _{CEsat}	collector-emitter saturation resistance	I_{C} = 0.5 A; I_{B} = 50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-	240	mΩ
TR2 (PNP)						
R _{CEsat}	collector-emitter saturation resistance	I _C = -0.5 A; I _B = -50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	-	360	mΩ

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E1	emitter TR1	6 5 4	C1 B2 E2
2	B1	base TR1		
3	C2	collector TR2	7 8	
4	E2	emitter TR2		
5	B2	base TR2	1 2 3 E1 B1 C2	E1 B1 C2
6	C1	collector TR1	Transparent top view DFN2020D-6 (SOT1118D)	sym139
7	C1	collector TR1	DI 142020D-0 (SOTTIOD)	
8	C2	collector TR2		

6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PBSS4160PANPS	DFN2020D-6	DFN2020D-6: plastic, thermally enhanced ultra thin and small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1118D				

7. Marking

Table 4. Marking codes	
Type number	Marking code
PBSS4160PANPS	3G

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Limiting values 8.

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
Per transis	tor; for the PNP transistor with	negative polarity				
V _{CBO}	collector-base voltage	open emitter		-	60	V
V _{CEO}	collector-emitter voltage	open base		-	60	V
V _{EBO}	emitter-base voltage	open collector		-	7	V
I _C	collector current			-	1	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	1.5	А
I _B	base current			-	0.3	А
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms		-	1	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	370	mW
			[2]	-	570	mW
		[3]	-	530	mW	
		[4]	-	700	mW	
			[5]	-	450	mW
			[6]	-	760	mW
			[7]	-	700	mW
			[8]	-	1450	mW
Per device						_
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	510	mW
			[2]	-	780	mW
			[3]	-	730	mW
			[4]	-	960	mW
			[5]	-	620	mW
			[6]	-	1040	mW
			[7]	-	960	mW
			[8]	-	2000	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint. [1] [2]

Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

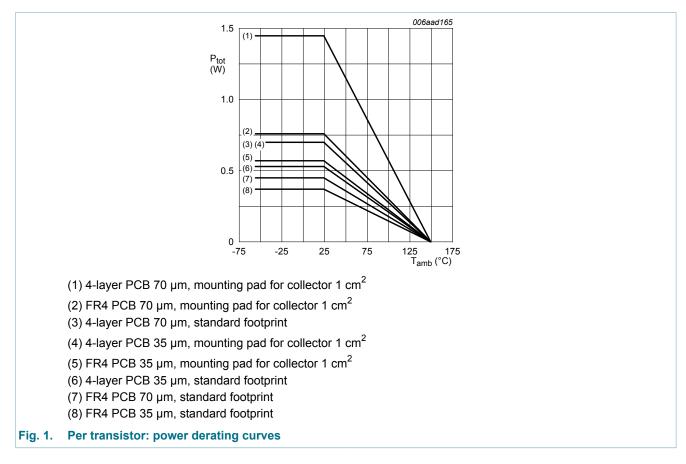
Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint. [3]

[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².

Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint. [5]

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- [6] Device mounted on an FR4 PCB, single-sided 70 μm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.
- [8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².



9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor	•	·					
R _{th(j-a)}	thermal resistance	in free air	[1]	-	-	338	K/W
from junction to ambient		[2]	-	-	219	K/W	
		[3]	-	-	236	K/W	
			[4]	-	-	179	K/W
			[5]	-	-	278	K/W
			[6]	-	-	164	K/W
			[7]	-	-	179	K/W
			[8]	-	-	86	K/W

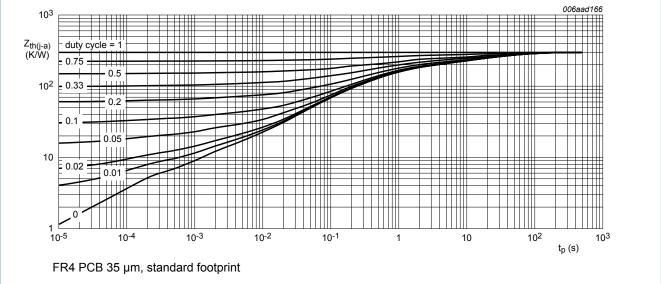
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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	30	K/W
Per device					·		
R _{th(j-a)} thermal resistance from junction to ambient		mal resistance in free air	[1]	-	-	245	K/W
		[2]	-	-	160	K/W	
	ampient		[3]	-	-	171	K/W
			[4]	-	-	130	K/W
			[5]	-	-	202	K/W
			[6]	-	-	120	K/W
			[7]	-	-	130	K/W
			[8]	-	-	63	K/W

- Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.
 Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.
- [4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.
- [6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².
- [7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

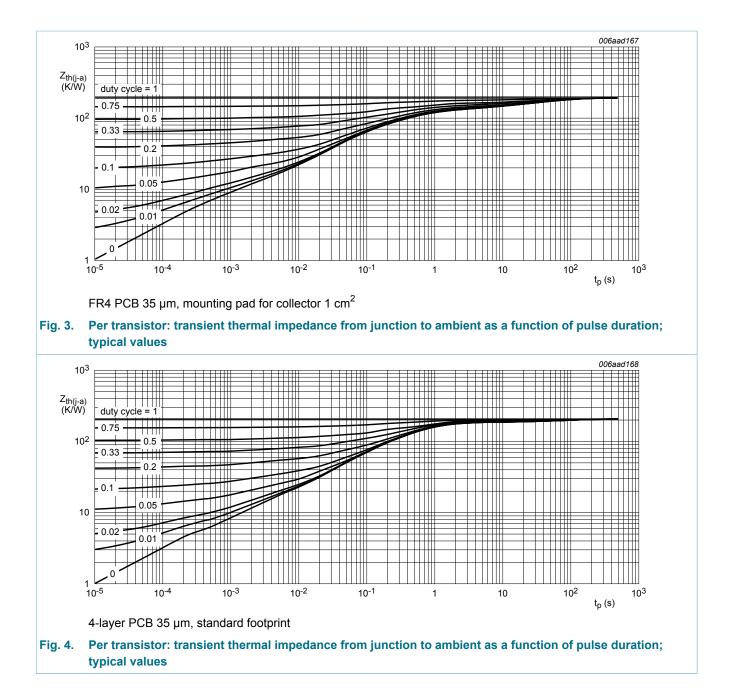
[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm².





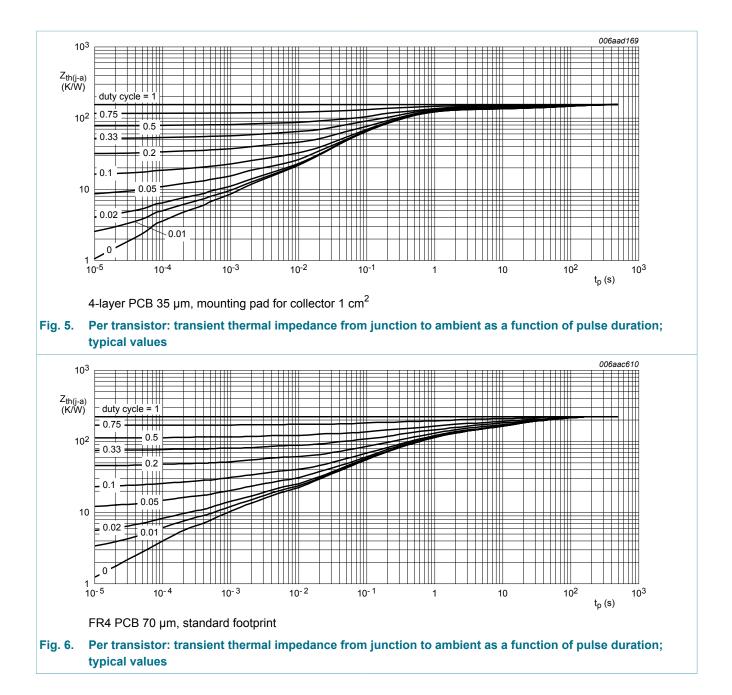
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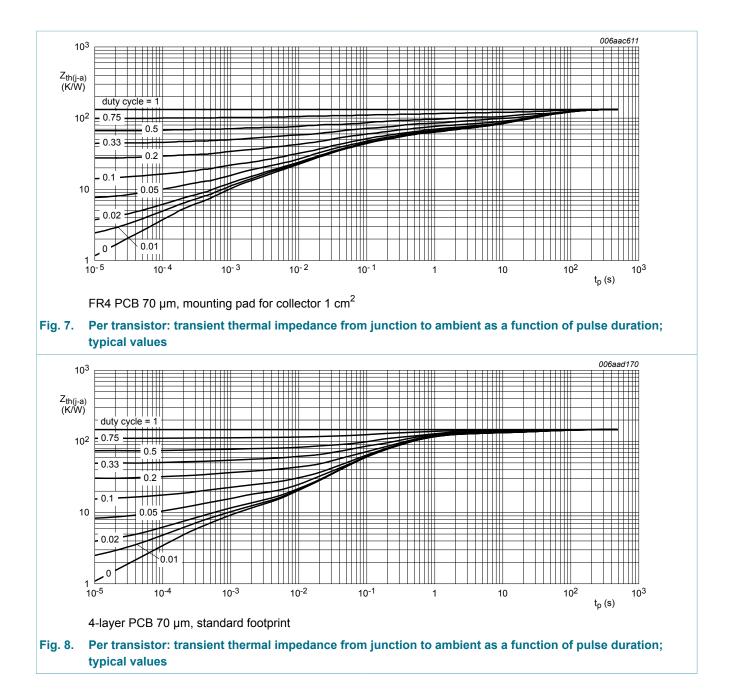
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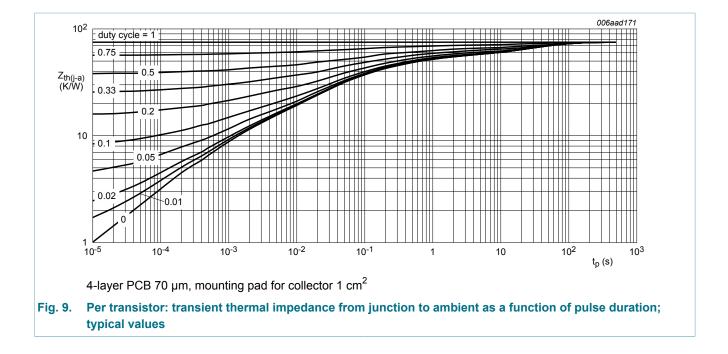
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10. Characteristics

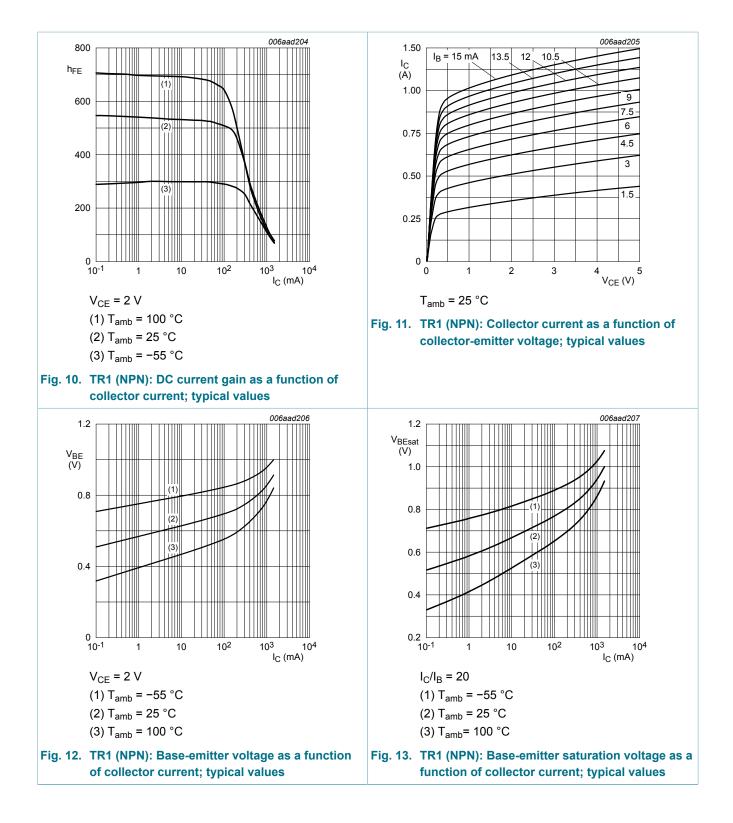
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (NPN)						
I _{CBO} collector-base cut-off		V _{CB} = 48 V; I _E = 0 A; T _{amb} = 25 °C	-	-	100	nA
	current	V _{CB} = 48 V; I _E = 0 A; T _j = 150 °C	-	-	50	μA
I _{EBO}	emitter-base cut-off current	V_{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	100	nA
h _{FE}	DC current gain	$\begin{split} &V_{CE} \texttt{= 2 V; I}_{C} \texttt{= 100 mA; pulsed;} \\ &t_{p} \texttt{\le 300 \mu s; } \delta \texttt{\le 0.02; T}_{amb} \texttt{= 25 °C} \end{split}$	290	430	-	
		V_{CE} = 2 V; I _C = 500 mA; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C	150	220	-	
		$\label{eq:Vce} \begin{array}{l} V_{CE} = 2 \; V; \; I_{C} = 1 \; A; \; pulsed; \; t_{p} \leq 300 \; \mu s; \\ \delta \leq 0.02; \; T_{amb} = 25 \; ^{\circ}C \end{array}$	70	110	-	
V _{CEsat}	collector-emitter	I_{C} = 500 mA; I_{B} = 50 mA; T_{amb} = 25 °C	-	90	120	mV
saturation voltage	saturation voltage	I_{C} = 1 A; I_{B} = 50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	185	240	mV
	I_{C} = 1 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	175	220	mV	
R _{CEsat}	collector-emitter saturation resistance	$\begin{split} I_{C} &= 0.5 \text{ A}; I_{B} = 50 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \delta \leq 0.02; T_{\text{amb}} = 25 ^{\circ}\text{C} \end{split}$	-	-	240	mΩ
V _{BEsat}	base-emitter saturation	I_{C} = 500 mA; I_{B} = 50 mA; T_{amb} = 25 °C	-	-	1	V
	voltage	$\begin{split} I_{C} &= 1 \text{ A}; I_{B} = 50 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	-	1.1	V
		I_{C} = 1 A; I_{B} = 100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-	1.1	V
V _{BEon}	base-emitter turn-on voltage	V_{CE} = 2 V; I _C = 0.5 A; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C	-	-	0.9	V
t _d	delay time	V_{CC} = 10 V; I _C = 0.5 A; I _{Bon} = 25 mA;	-	15	-	ns
t _r	rise time	I _{Boff} = -25 mA; T _{amb} = 25 °C	-	90	-	ns
t _{on}	turn-on time	-	-	105	-	ns
t _s	storage time	-	-	410	-	ns
t _f	fall time		-	130	-	ns
t _{off}	turn-off time		-	540	-	ns
f _T	transition frequency	V _{CE} = 10 V; I _C = 50 mA; f = 100 MHz; T _{amb} = 25 °C	90	175	-	MHz
C _c	collector capacitance	V _{CB} = 10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	4	6	pF

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR2 (PNP)						,
020		V _{CB} = -48 V; I _E = 0 A	-	-	-100	nA
	current	V_{CB} = -48 V; I _E = 0 A; T _j = 150 °C	-	-	-50	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = -5 V; I _C = 0 A	-	-	-100	nA
h _{FE}	DC current gain	$\label{eq:VcE} \begin{array}{l} V_{CE} = -2 \; V; \; I_{C} = -100 \; mA; \; pulsed; \\ t_{p} \leq 300 \; \mus; \; \delta \leq 0.02; \; T_{amb} = 25 \; ^{\circ}C \end{array}$	170	245	-	
		$ \begin{aligned} &V_{CE} = -2 \text{ V; } I_C = -500 \text{ mA; pulsed;} \\ &t_p \leq 300 \mu\text{s; } \delta \leq 0.02\text{; } T_{amb} = 25 ^\circ\text{C} \end{aligned} $	120	170	-	
		$\begin{split} &V_{CE} \texttt{= -2 V; I}_{C} \texttt{= -1 A; pulsed;} \\ &t_{p} \texttt{\leq 300 \mu s; \delta \texttt{\leq } 0.02; T}_{amb} \texttt{= 25 °C} \end{split}$	70	100	-	
V _{CEsat}	collector-emitter saturation voltage	I_C = -500 mA; I_B = -50 mA; pulsed; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-125	-180	mV
		I_{C} = -1 A; I_{B} = -50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-390	-550	mV
		I_{C} = -1 A; I_{B} = -100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-240	-340	mV
R _{CEsat}	collector-emitter saturation resistance	$\begin{split} I_{C} &= -0.5 \text{ A}; I_{B} = -50 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300 \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	-	360	mΩ
V _{BEsat}	base-emitter saturation voltage	I_{C} = -500 mA; I_{B} = -50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-	-1	V
		I_{C} = -1 A; I_{B} = -50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-	-1	V
		I_{C} = -1 A; I_{B} = -100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-	-1.1	V
V _{BEon}	base-emitter turn-on voltage	$\label{eq:VcE} \begin{array}{l} V_{CE} \texttt{=} \texttt{-2} \; V \texttt{;} \; I_{C} \texttt{=} \texttt{-0.5} \; A \texttt{;} \; \texttt{pulsed} \texttt{;} \\ t_{p} \texttt{\leq} \texttt{300} \; \mu \texttt{s} \texttt{;} \; \delta \texttt{\leq} \texttt{0.02} \texttt{;} \; T_{amb} \texttt{=} \texttt{25} \; ^{\circ} C \end{array}$	-	-	-0.9	V
t _d	delay time	V_{CC} = -10 V; I _C = -0.5 A; I _{Bon} = -25 mA;	-	15	-	ns
t _r	rise time	I _{Boff} = 25 mA; T _{amb} = 25 °C	-	40	-	ns
t _{on}	turn-on time		-	55	-	ns
t _s	storage time		-	95	-	ns
t _f	fall time		-	40	-	ns
t _{off}	turn-off time		-	135	-	ns
f _T	transition frequency	V_{CE} = -10 V; I _C = -50 mA; f = 100 MHz; T _{amb} = 25 °C	65	125	-	MHz
C _c	collector capacitance	V _{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	9.5	13	pF

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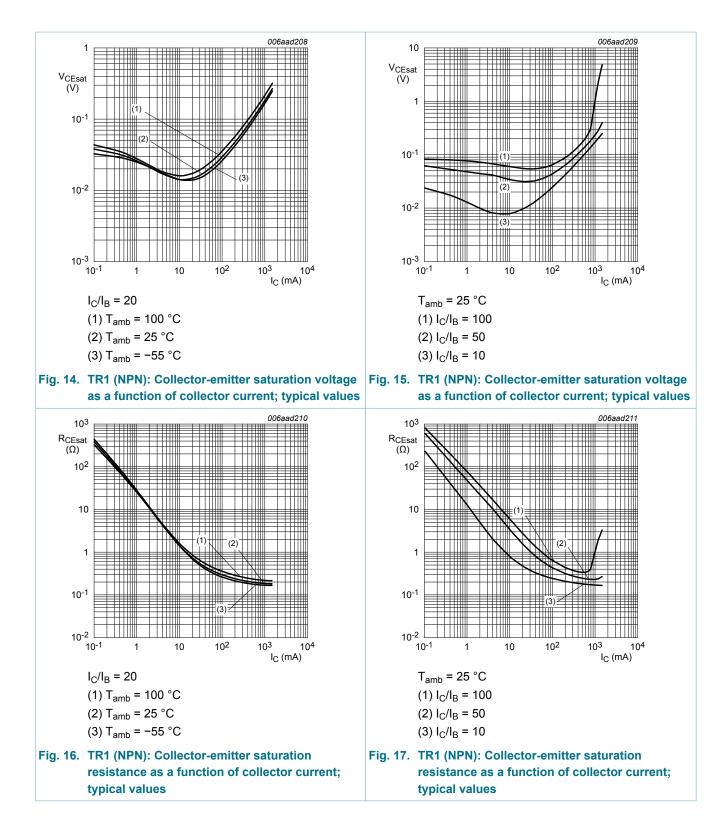
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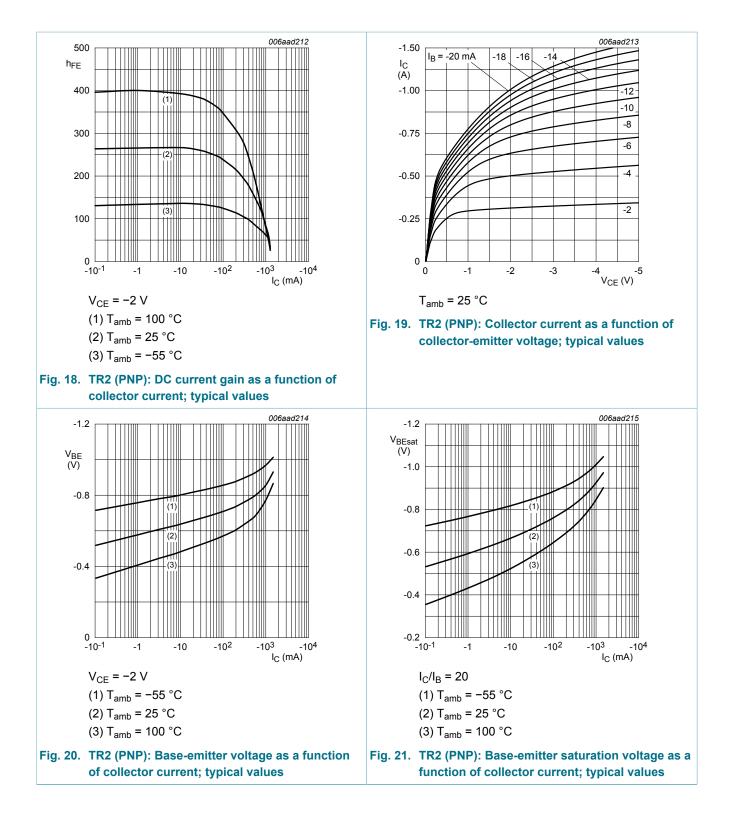
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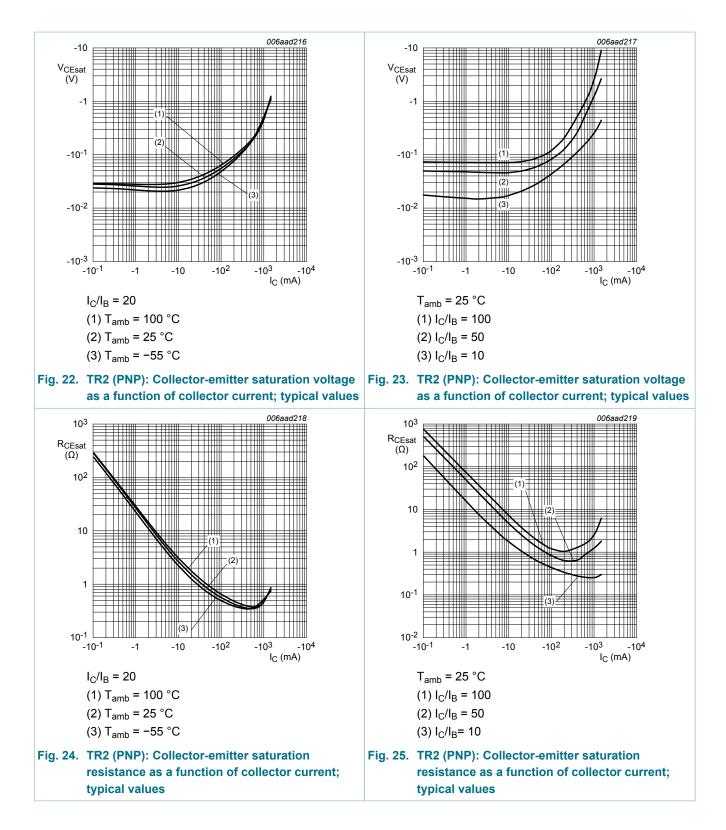
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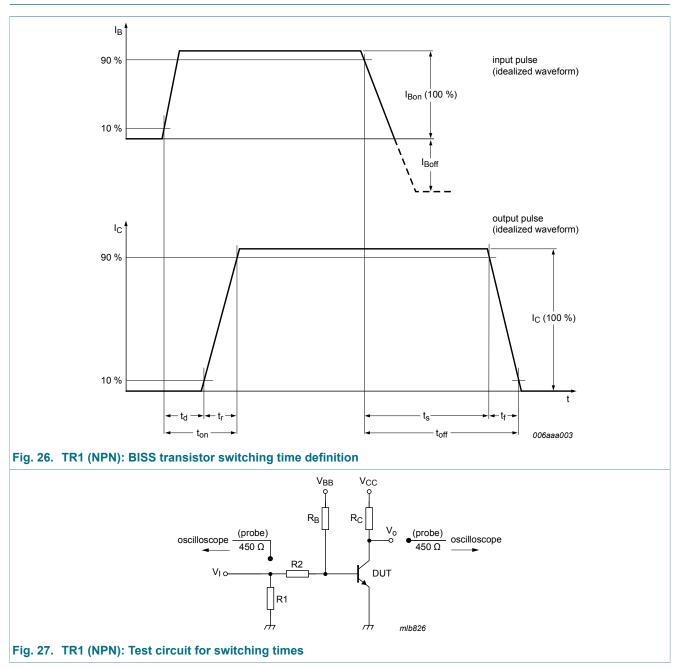
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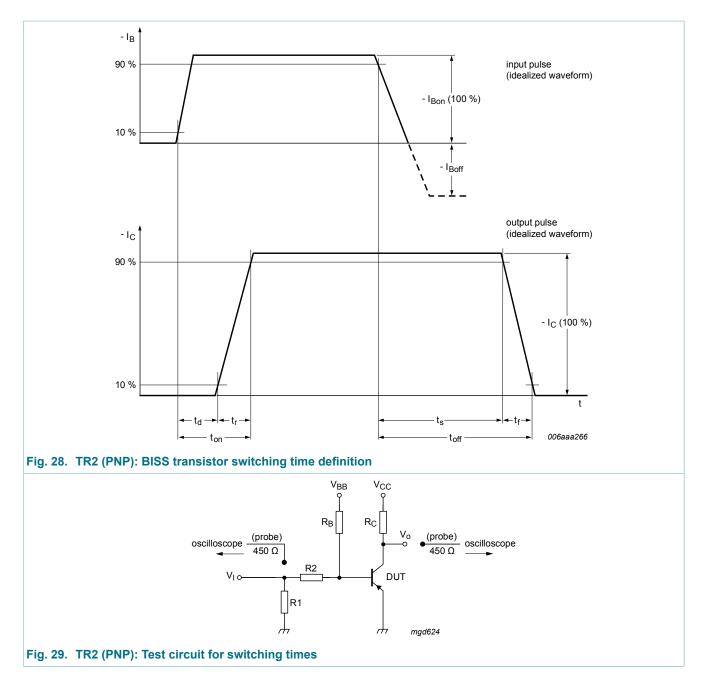
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11. Test information

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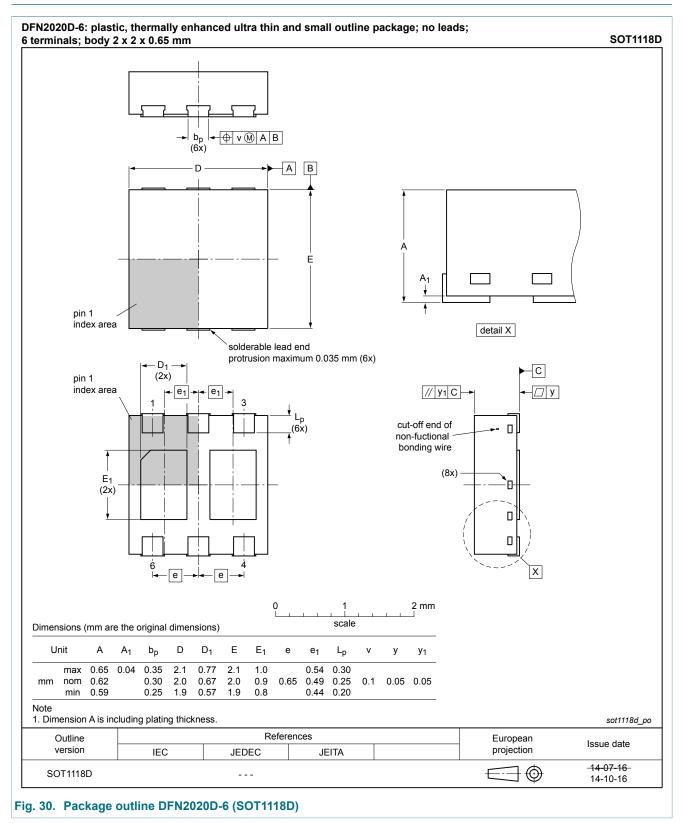
11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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12. Package outline

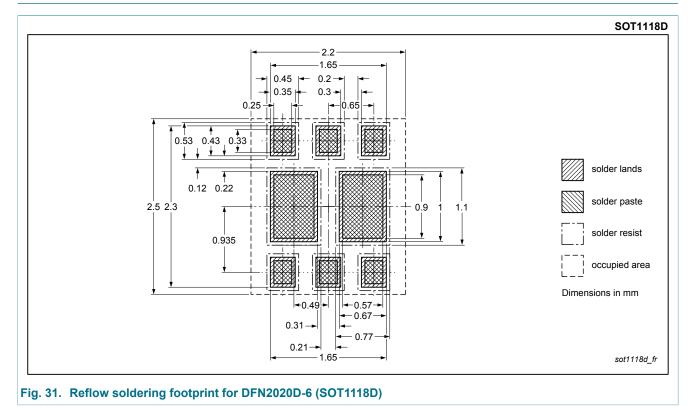


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13. Soldering



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14. Revision history

Table 8. Revision his	Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PBSS4160PANPS v.1	20150211	Product data sheet	-	-			

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nexperia.com</u>.

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60 V, 1 A NPN/NPN low VCEsat (BISS) transistor

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